

LOW-NOISE VERTICAL DEFLECTION SYSTEM

FEATURES SUMMARY

- COMPLETE VERTICAL DEFLECTION SYSTEM
- LOW NOISE
- SUITABLE FOR HIGH DEFINITION MONITORS
- ESD PROTECTED

DESCRIPTION

The TDA1175P is a monolithic integrated circuit in POWERDIP16 plastic package. It is intended for use in black and white and colour TV receivers. Low-noise makes this device particularly suitable for use in monitors.

The functions incorporated are: synchronization circuit, oscillator and ramp generator, high power gain amplifier, flyback generator, voltage regulator.

Figure 1. Package

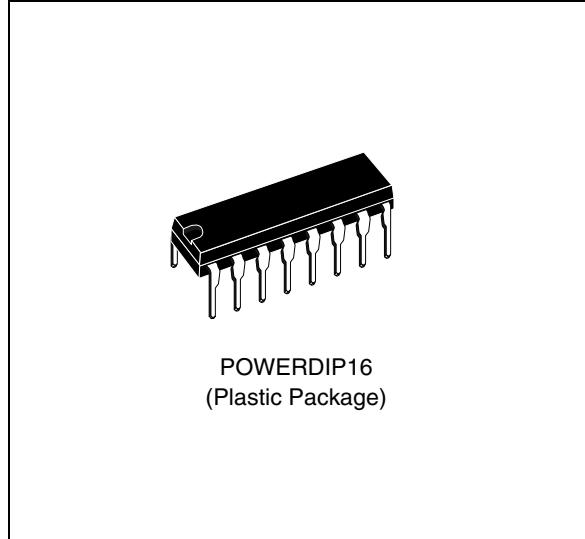


Figure 2. Pin Connections

RAMP OUTPUT	<input type="checkbox"/>	1	<input type="checkbox"/>	RAMP GENERATOR
SUPPLY VOLTAGE	<input type="checkbox"/>	2	<input type="checkbox"/>	COMPENSATION
FLYBACK	<input type="checkbox"/>	3	<input type="checkbox"/>	AMP. INPUT
GROUND	<input type="checkbox"/>	4	<input type="checkbox"/>	GROUND
GROUND	<input type="checkbox"/>	5	<input type="checkbox"/>	GROUND
POWER AMPLIFIER OUTPUT	<input type="checkbox"/>	6	<input type="checkbox"/>	OSCILLATOR
POWER AMPLIFIER SUPPLY VOLTAGE	<input type="checkbox"/>	7	<input type="checkbox"/>	SYNC. INPUT
REGULATED VOLTAGE	<input type="checkbox"/>	8	<input type="checkbox"/>	HEIGHT ADJUSTMENT

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Figure 3. Block Diagram

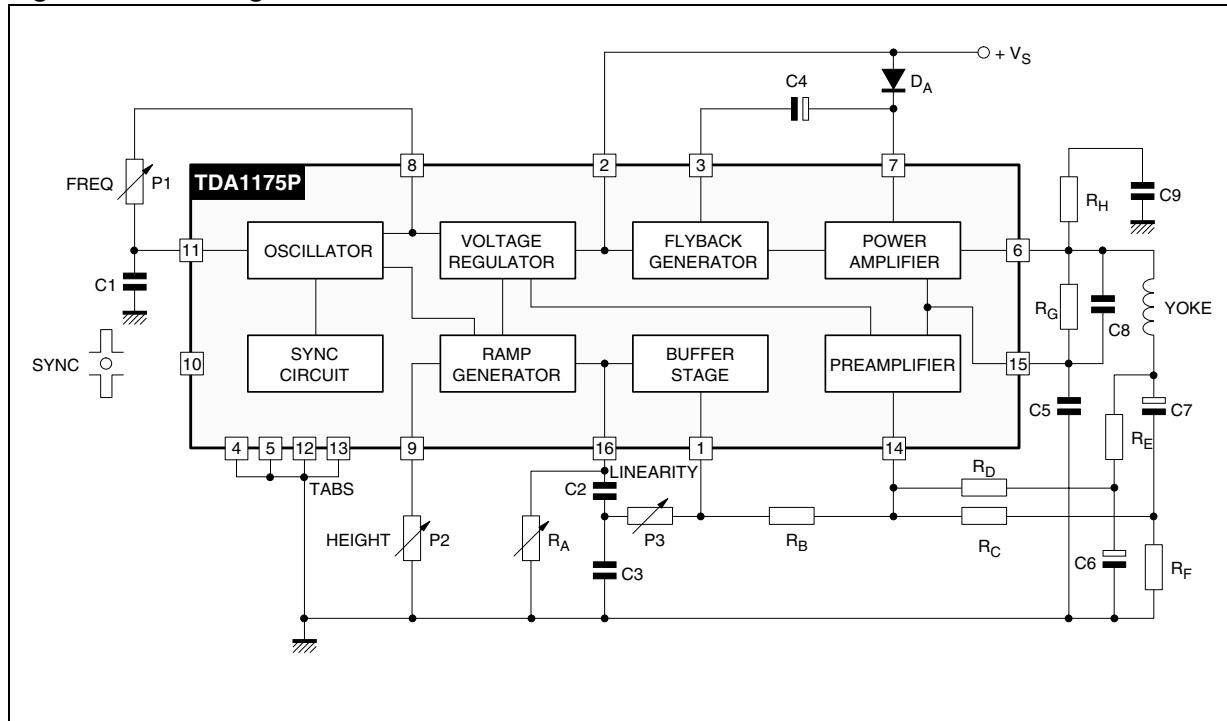


Table 1. Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_S	Supply Voltage at Pin 2	35	V
V_6, V_7	Flyback Peak Voltage	60	V
V_{14}	Power Amplifier Input Voltage	+ 10 - 0.5	V
I_O	Output Peak Current (non repetitive) at $t = 2\text{ms}$	2	A
I_O	Output Peak Current at $f = 50\text{Hz}, t \leq 10\mu\text{s}$	2.5	A
I_O	Output Peak Current at $f = 50\text{Hz}, t > 10\mu\text{s}$	1.5	A
I_3	Pin 3 DC Current at $V_6 < V_2$	100	mA
I_3	Pin 3 Peak to Peak Flyback Current for $f = 50\text{Hz}, t_{fly} \leq 1.5\text{ms}$	1.8	A
I_{10}	Pin 10 Current	± 20	mA
P_{TOT}	Power Dissipation at $T_{tab} = 90^\circ\text{C}$	4.3	W
	Power Dissipation at $T_{amb} = 70^\circ\text{C}$ (free air) (1)	1	W
T_{STG}, T_j	Storage and Junction Temperature	- 40 to 150	$^\circ\text{C}$

Table 2. Thermal Data

Symbol	Parameter	Value	Unit
R_{th} (j-tab)	Thermal Resistance Junction-pin Max.	12	$^\circ\text{C/W}$
R_{th} (j-amb)	Thermal Resistance Junction-ambient Max.	80	$^\circ\text{C/W}^{(1)}$

Note: 1. Obtained with tabs soldered to printed circuit with minimized copper area.

ELECTRICAL CHARACTERISTICS
 ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

Table 3. DC CHARACTERISTICS
 (Refer to the test circuits, $V_S = 35\text{V}$)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	Fig.
I_2	Pin 2 Quiescent Current	$I_3 = 0$		7	14	mA	5
I_7	Pin 7 Quiescent Current	$I_6 = 0$		8	17	mA	5
$-I_{11}$	Oscillator Bias Current	$V_{11} = 1\text{V}$		0.1	1	μA	4
$-I_{14}$	Amplifier Input Bias Current	$V_{14} = 1\text{V}$		1	10	μA	5
$-I_{16}$	Ramp Generator Bias Current	$V_{16} = 0$		0.02	0.3	μA	4
$-I_{16}$	Ramp Generator Current	$I_9 = 20\mu\text{A}, V_{16} = 0$	18.5	20	21.5	μA	5
$\frac{\Delta I_{16}}{I_{16}}$	Ramp Generator Non-linearity	$\Delta V_{16} = 0 \text{ to } 12\text{V}, I_9 = 20\mu\text{A}$		0.2	1	%	5
V_S	Supply Voltage Range		10		35	V	
V_1	Pin 1 Saturation Voltage to Ground	$I_1 = 1\text{mA}$		1	14	V	
V_3	Pin 3 Saturation Voltage to Ground	$I_3 = 10\text{mA}$		1.5	2.5	V	4
V_6	Quiescent output Voltage	$V_S = 10\text{V}, R1 = 1\text{k}\Omega, R2 = 1\text{k}\Omega$ $V_S = 35\text{V}, R1 = 3\text{k}\Omega, R2 = 1\text{k}\Omega$	4.1 8.2	4.4 8.8	4.7 9.4	V	4
V_{6L}	Output Saturation Voltage to Ground	$-I_6 = 0.1\text{A}$ $-I_6 = 0.8\text{A}$		0.9 1.8	1.2 2.2	V	6
V_{6H}	Output Saturation Voltage to Supply	$I_6 = 0.1\text{A}$ $I_6 = 0.8\text{A}$		1.4 2.8	2.1 3.1	V	7
V_8	Regulated Voltage at Pin 8		6.5	6.7	6.9	V	5
V_9	Regulated Voltage at Pin 9	$I_9 = 20\mu\text{A}$	6.6	6.8	7	V	5
$\frac{ \Delta V_8 }{\Delta V_S}$ $\frac{ \Delta V_9 }{\Delta V_S}$	Regulated Voltage Drift with Supply Voltage	$\Delta V_S = 10 \text{ to } 35\text{V}$		1	2	mV/V	5
V_{14}	Amplifier Input Reference Voltage	$V_{10} \leq 0.4\text{V}$	2.20	2.27	2.35	V	

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Table 4. AC CHARACTERISTICS

(Refer to the AC test circuit, $V_S = 22V$, $f = 50Hz$)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	Fig.
I_S	Supply Current	$I_Y = 1A_{APP}$		140		mA	8
I_{10}	Sync. Input Current (positive or negative)		0.5		2	mA	8
V_6	Flyback Voltage	$I_Y = 1A_{APP}$		45		V	8
t_{fly}	Flyback Time	$I_Y = 1A_{APP}$		0.7		ms	8
V_{ON}	Peak to Peak Output Noise	Pin 11 Connected to GND		18	30	mV_{pp}	8
f_O	Free Running Frequency	$(P1 + R1) = 300k\Omega$ $C9 = 0.1 \mu F$	36	43.5		Hz	8
f_{OPER}	Operating Frequency Range		10		120	Hz	8
Δf	Synchronization Range	$I_{10} = 0.5mA$, $C9 = 0.1\mu F$ $(P1+R1) = 300k\Omega$	14			Hz	8
$\frac{\Delta f}{\Delta V_S}$	Frequency Drift with Supply Voltage	$V_S = 10$ to $35V$		0.00 5		Hz/V	8
$\frac{ \Delta f }{\Delta T_{ab}}$	Frequency Drift with tab Temperature	$T_{tab} = 40$ to $120^\circ C$		0.01		Hz/ $^\circ C$	8

DC TEST CIRCUITS

Figure 4.

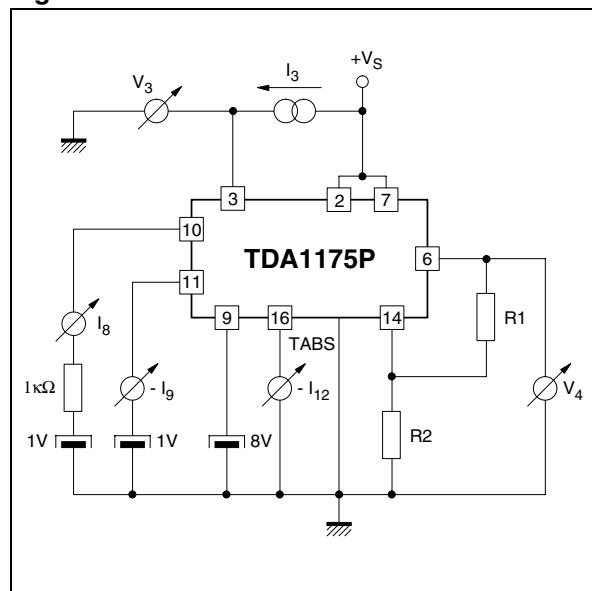


Figure 6.

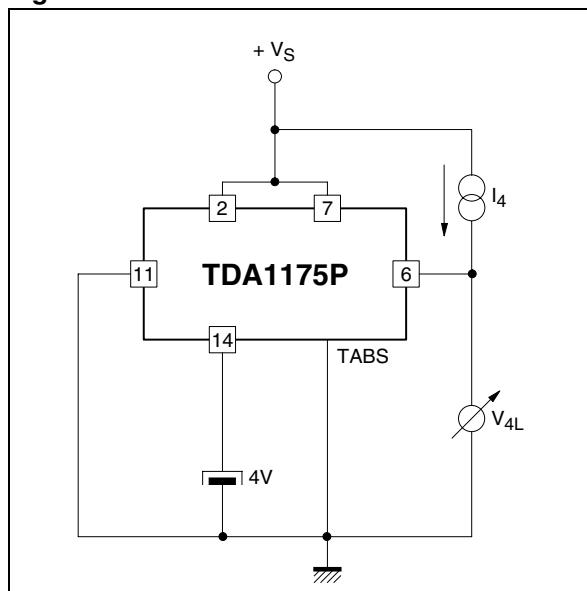


Figure 5.

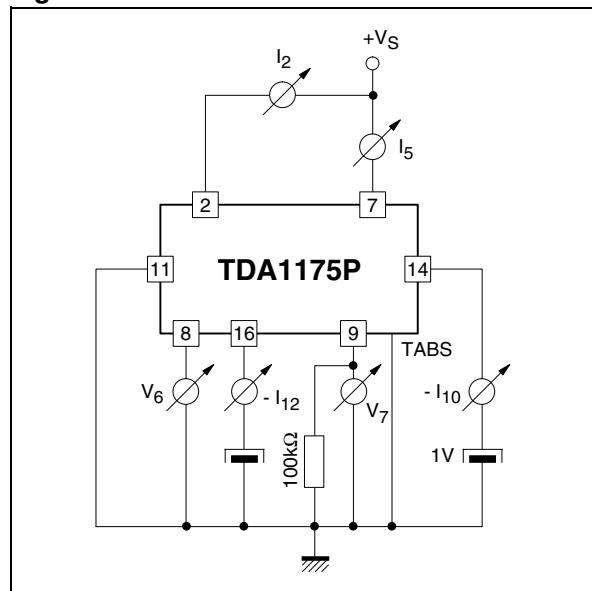
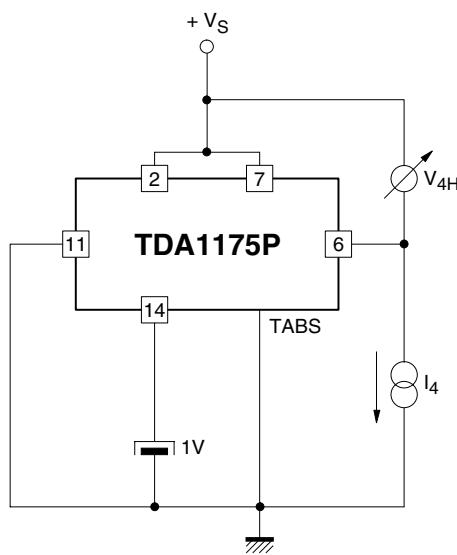


Figure 7.



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Figure 8. AC Test and Application Circuit for Large Screen B/W TV Set 10Ω/20mH/1A_{PP}

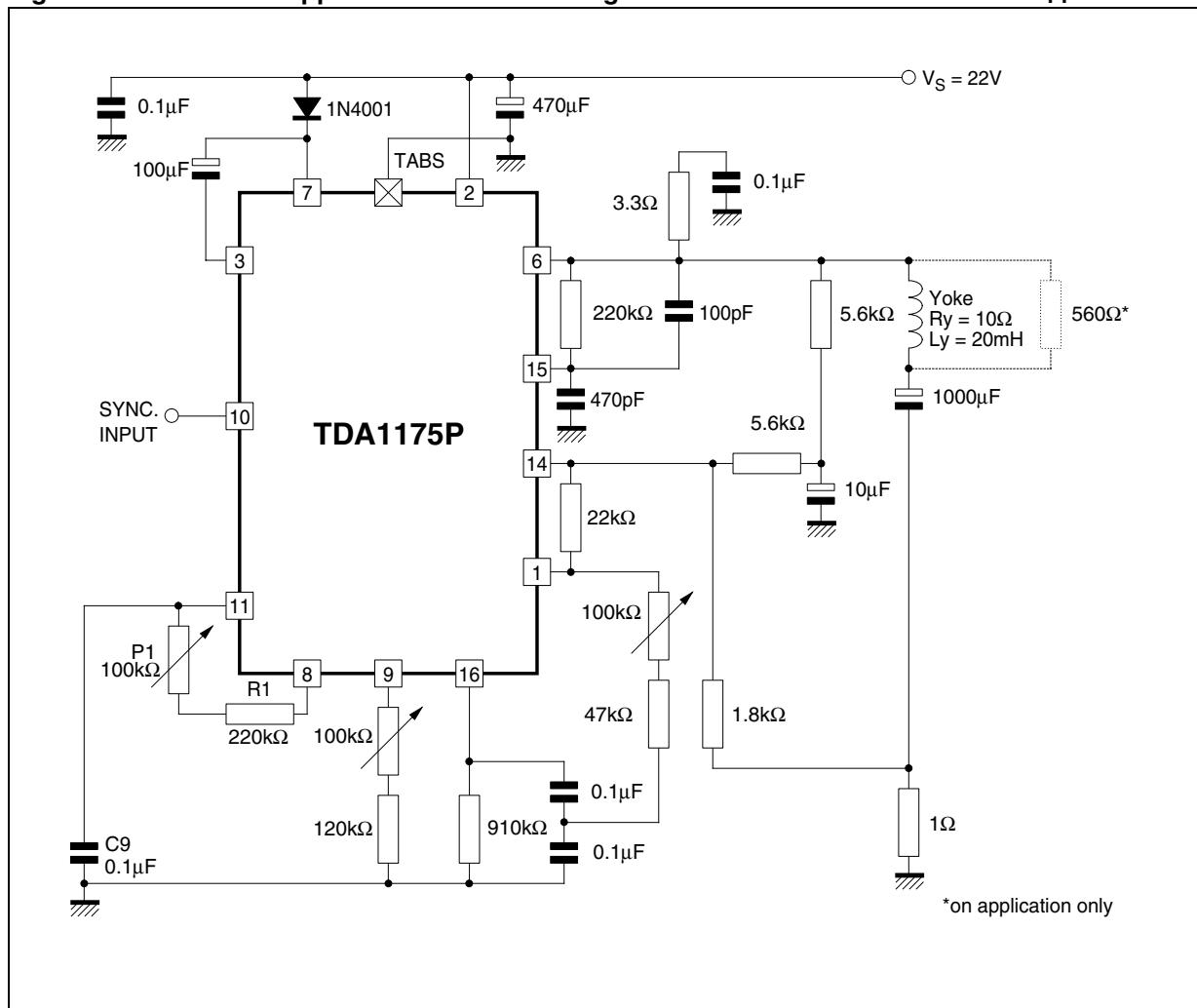
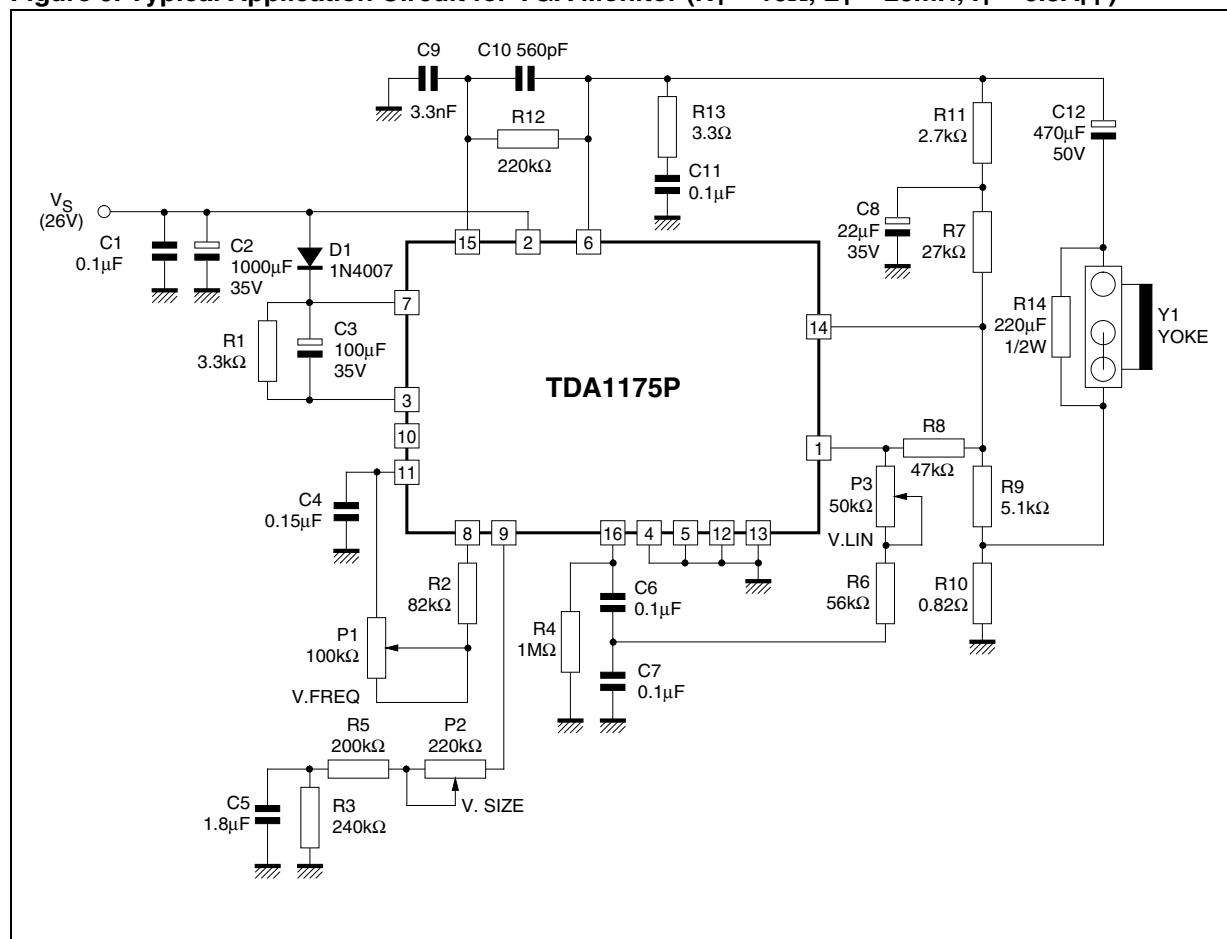


Figure 9. Typical Application Circuit for VGA Monitor ($R_Y = 10\Omega$, $L_Y = 20mH$, $I_Y = 0.8A_{PP}$)

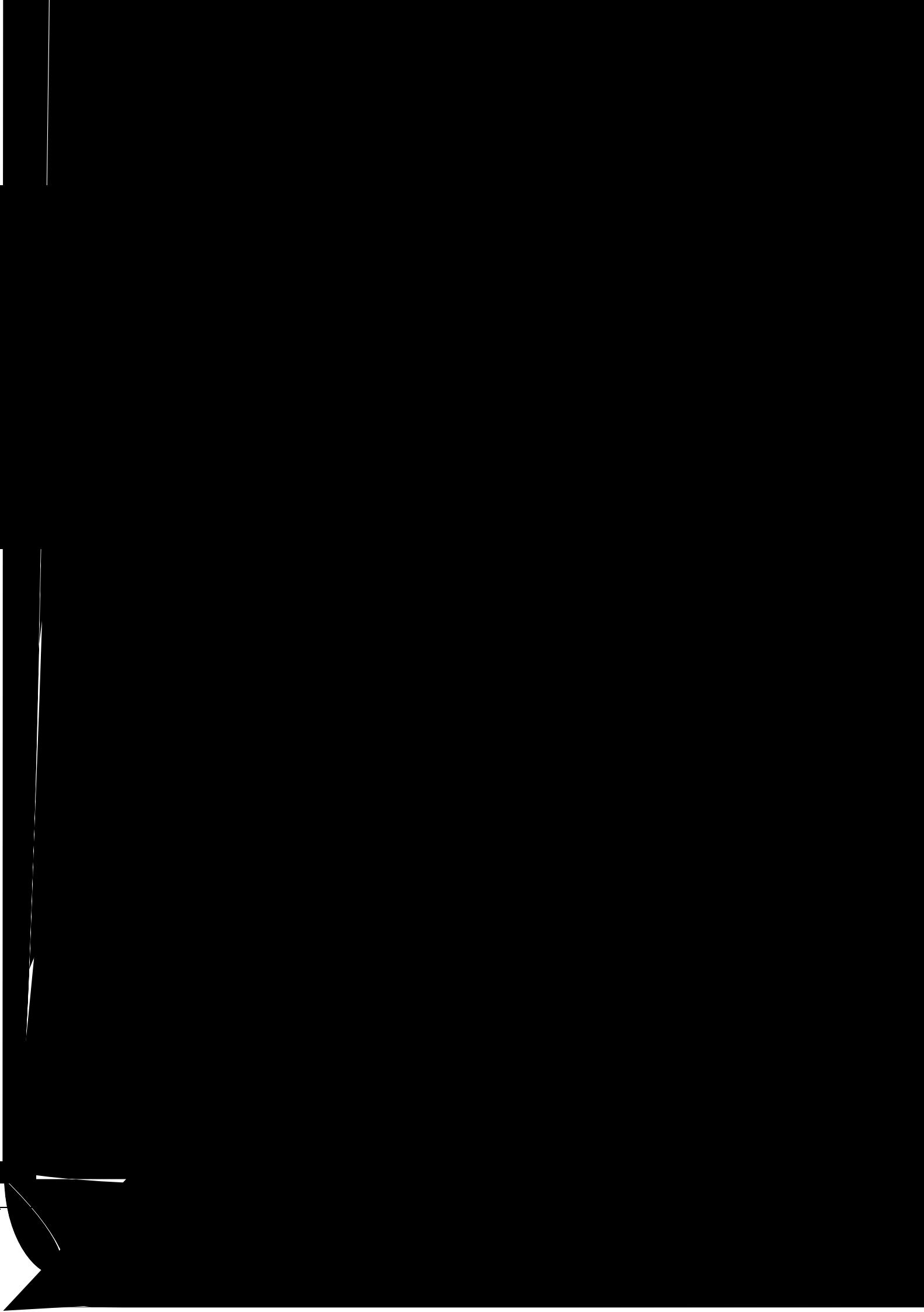


Figure 14. Maximum Allowable Dissipation versus Ambient Temperature

Figure 12. External Heatsink Mounting Example

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PART NUMBERING

Table 6. Order Codes

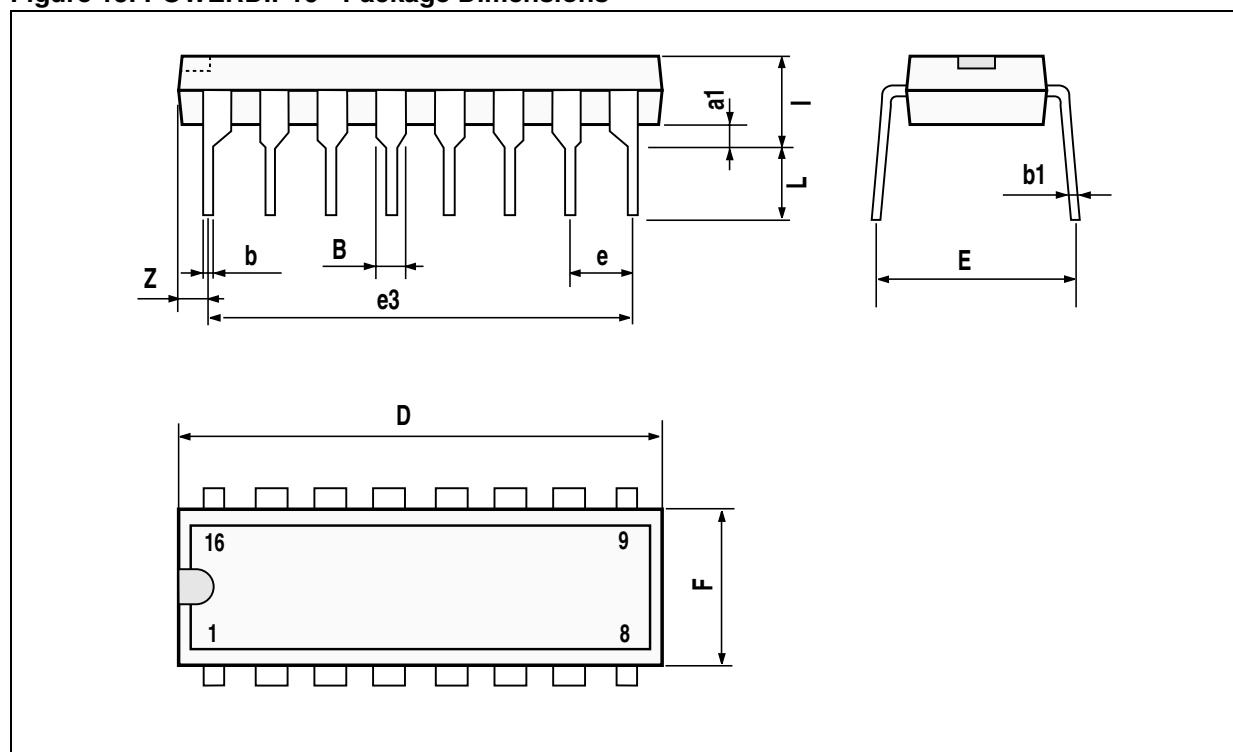
Part Number	Package	Temperature Range
TDA1175P	POWERDIP16	-25 to 85 °C

PACKAGE MECHANICAL

Table 7. POWERDIP16 - Mechanical Data

Symbol	millimeters			inches		
	Typ	Min	Max	Typ	Min	Max
a1	0.51			0.020		
B	0.85		1.4	0.033		0.055
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			20			0.787
E		8.8			0.346	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
i			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050

Figure 15. POWERDIP16 - Package Dimensions



Note: Drawing is not to scale

TDA1175P

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